

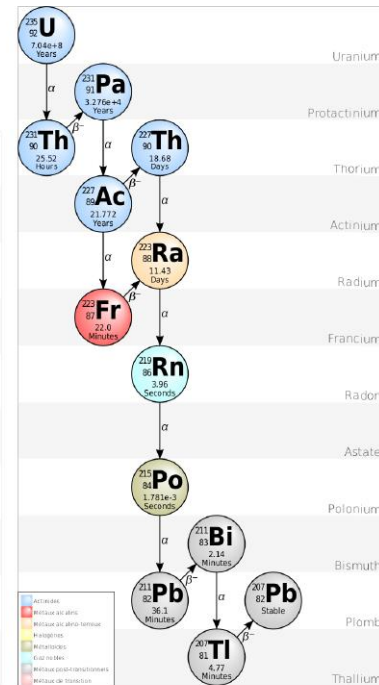
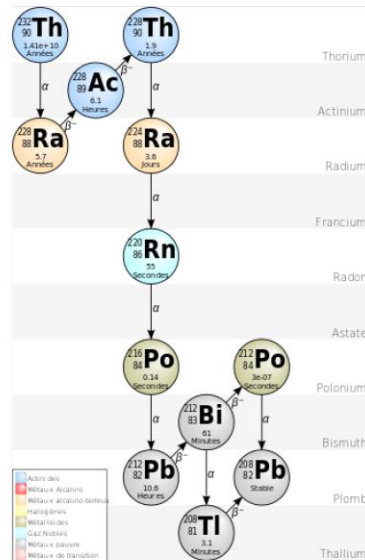
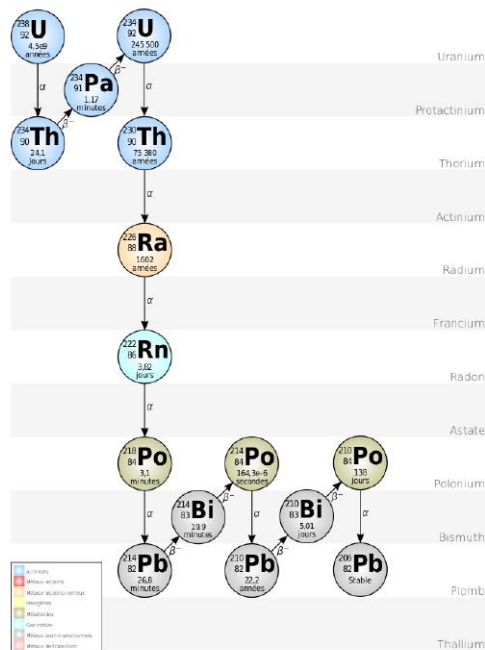


Radon surface contamination

Simulation of implantation depth

Radon Context

- Radioactive gas emanating from soil, rocks
- It decays and its daughter are contamination source
- Radon is everywhere

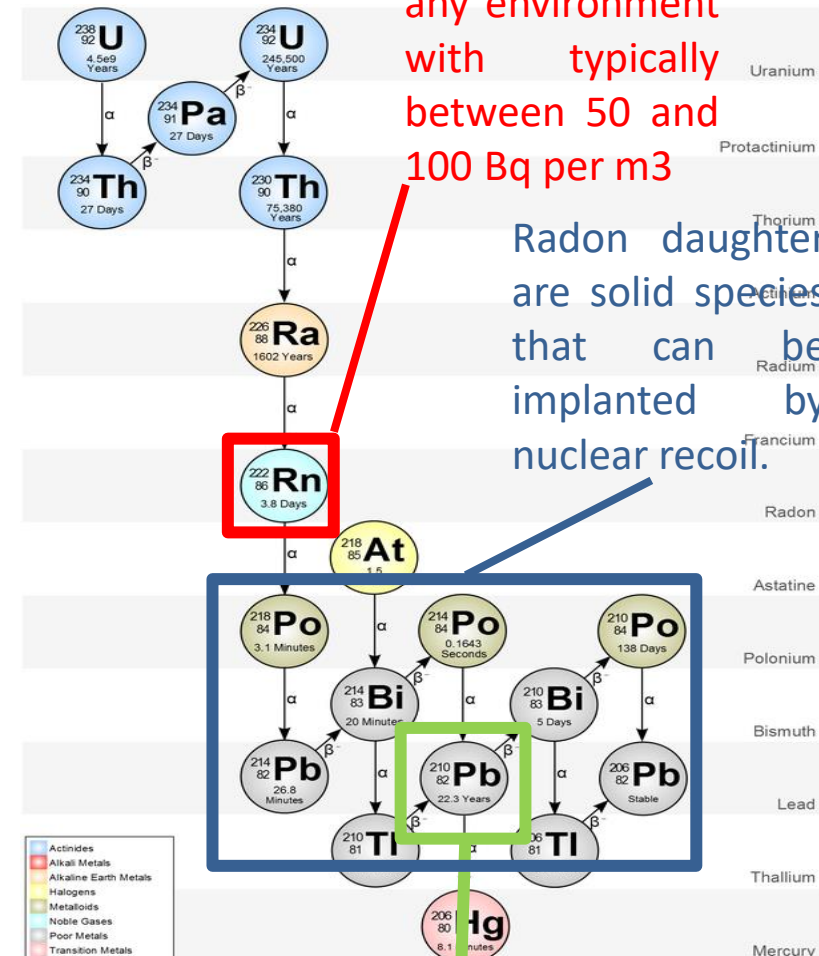


Radon contribution to background

- Gas travelling to the vicinity of the detector
- Radioactive decay produce radiative background
- Nuclear recoil implants radon daughter
- Can happen during whole detector construction

Radon 222 is a gas emanating in any environment with typically between 50 and 100 Bq per m³

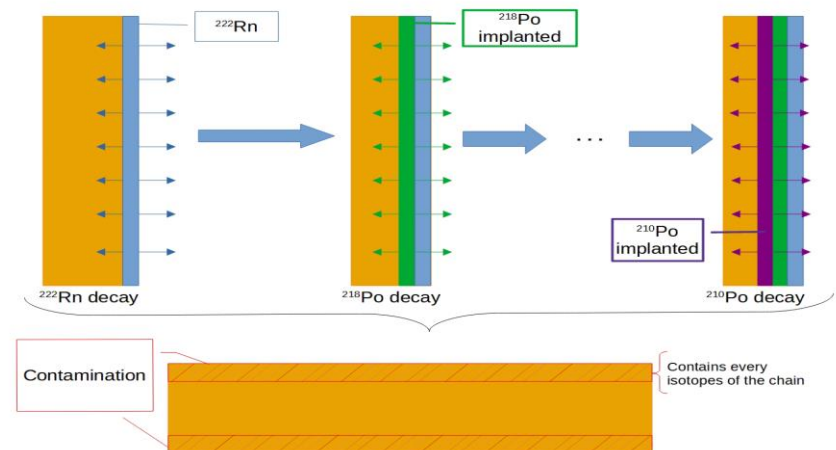
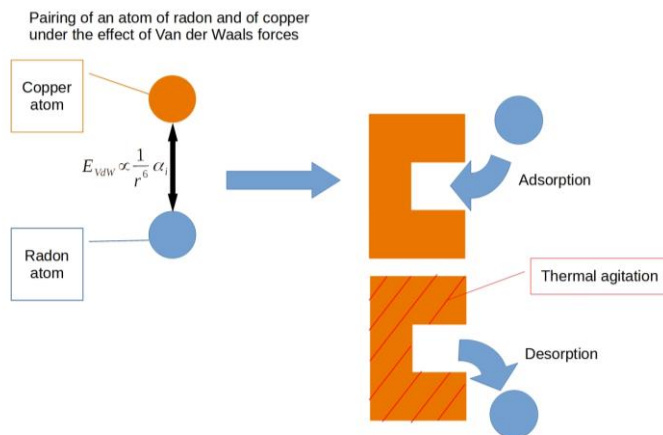
Radon daughter are solid species that can be implanted by nuclear recoil.



210 Pb has the longest half life in this part of the chain thus piloting the contamination and its duration

Radon implantation mechanism

- Radon has a probability to adsorb on the surface and then decay on his surface
- The adsorption depends on thermodynamical parameter
- After adsorption the radon daughter have a chance to decay and implant ^{218}Po by nuclear recoil, repeat with daughter



Mitigation of radon backgrounds

- During run of low-background experiment radon is flushed away from vicinity of detector typically using adsorption column
- During construction implantation of radon daughter is accumulating, so surfaces are usually etched to reduce implanted daughter background. Moreover critical pieces need to be transported shielded from radon

Examples of LSM former radon free air facility

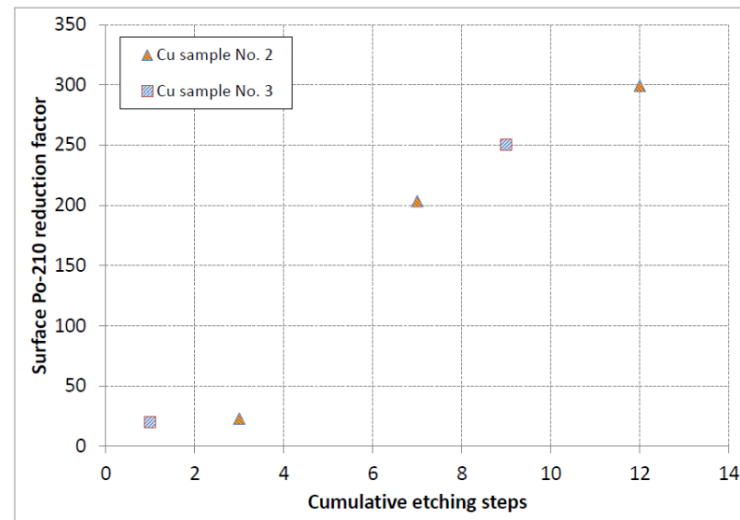


2 x 500 kg charcoal (only one used)
Flux : 150 m³/h air
Activity of ²²²Rn :
Before facility = 15 Bq/m³
After facility < 15 mBq/m³

Implantation removal

- Strategy was usually to etch the copper surfaces with acid mixture ($\text{HNO}_3/\text{H}_2\text{O}_2$)
- Process has been refined using electrochemical polishing
- Depth up to $100\mu\text{m}$ are removed
- Contamination removal is probed through ^{210}Po surface activity
- ^{210}Po chemical redeposes after etching

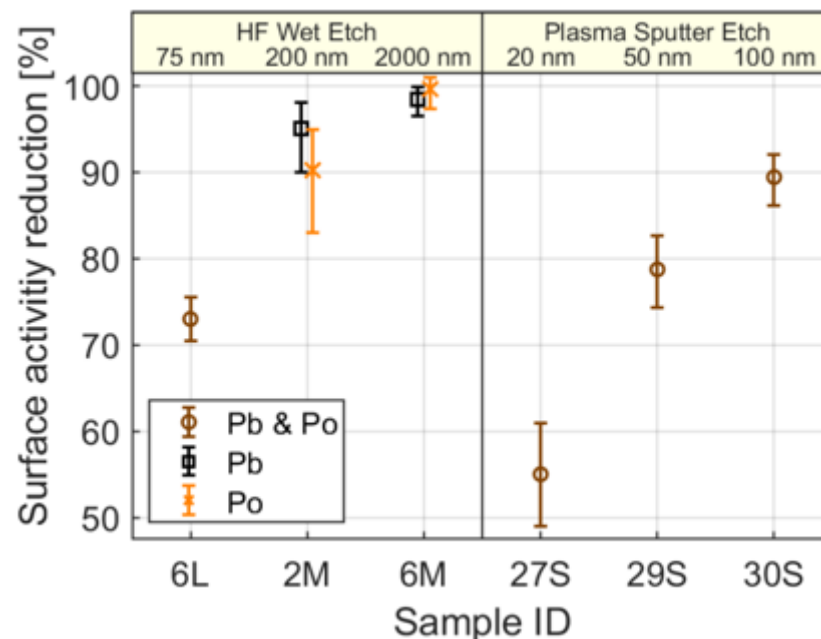
See G. Zuzel, M. Czubak, T. Mróz, M. Wójcik; Institute of Physics
Jagiellonian University, Cracow,
Poland Low Radioactivity Techniques
2022, 14-17 June 2022, South
Dakota Mines / SURF, USA



Implantation removal

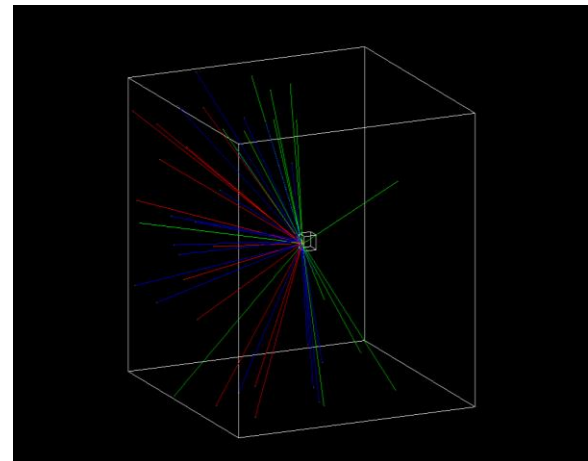
- Implantation mechanism comes from nuclear recoil. Available energy $\sim 100\text{keV}$
- Implantation depth average 50nm and strongly depending on material
- Also backed with non-chemical cleaning techniques

Precision etching was tried on silicon wafer. It showed that main contamination could be removed by only a 100nm. This value is more compatible with the recoil energy as an implantation mechanism



Implantation model

- Implantation modeled through GEANT4
- Use of rdecay package to have the full chain implantation
- Radon position on the surface and full decay monitored
- Altitude 0 on copper plate
- Recorded final step depth per nucleus
- 1D plot obtained

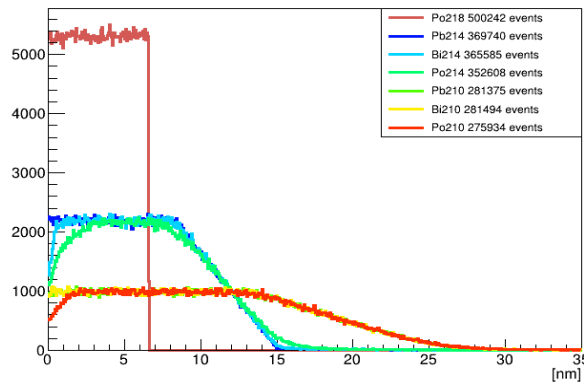


First tests

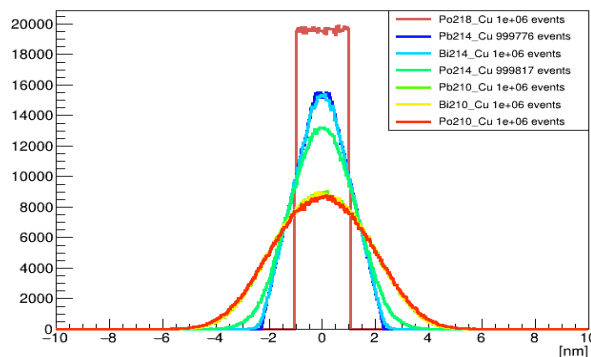
- Strange shape and non continuous models

Decay at (0,0,0) and inside the copper plate

Position of decays following 10^6 decays of ^{222}Rn on surface of Si

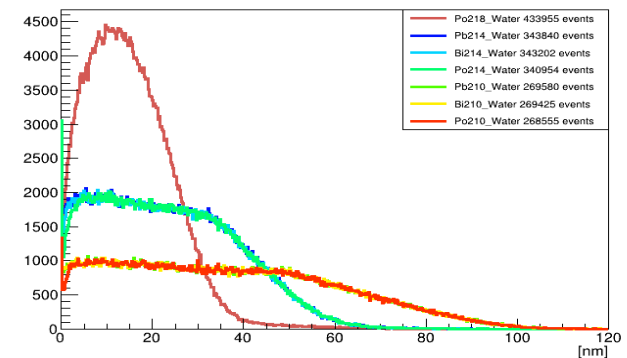


Position of decays following $1\text{E}6$ decays of ^{222}Rn at the center of Cu



Decays at (0,0,1 nm)

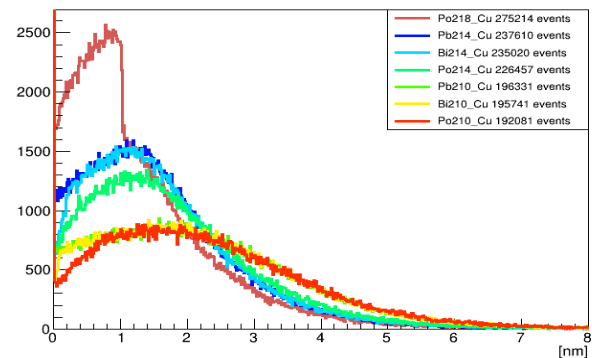
Position of decays following $1\text{E}6$ decays of ^{222}Rn at 1nm from the surface of water



Multiple scattering model
(G4UrbanMscModel)

Coulomb scattering process

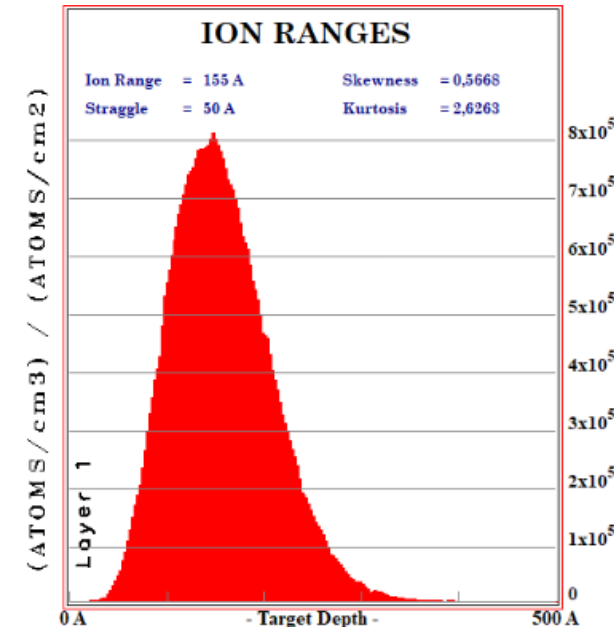
Position of decays following $1\text{E}6$ decays of ^{222}Rn at 1nm from the surface of Cu



The coulomb scattering process produces smoother simulation, is triggered by transportation. It can also be forced by reducing G4step

Comparison to SRIM

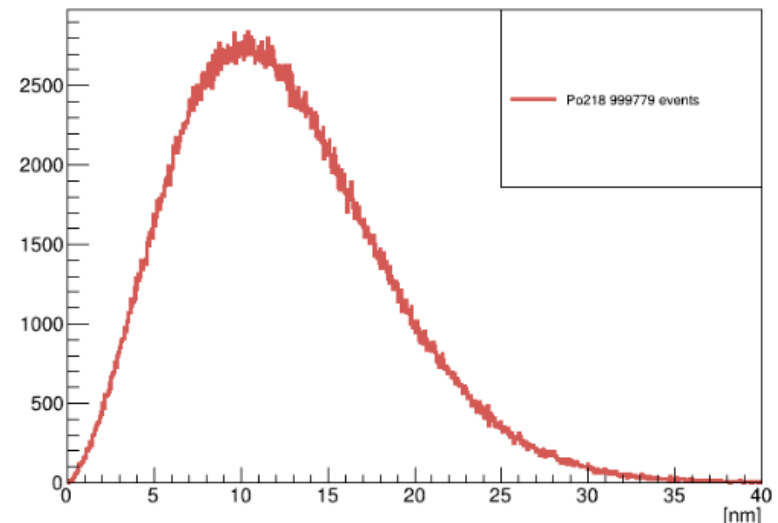
- SRIM ion is recognized accurate
- Comparizon with rdecay only physics list is dramatic
- Use of StandardNR process to reproduce SRIM



218Po Beam
101keV energy



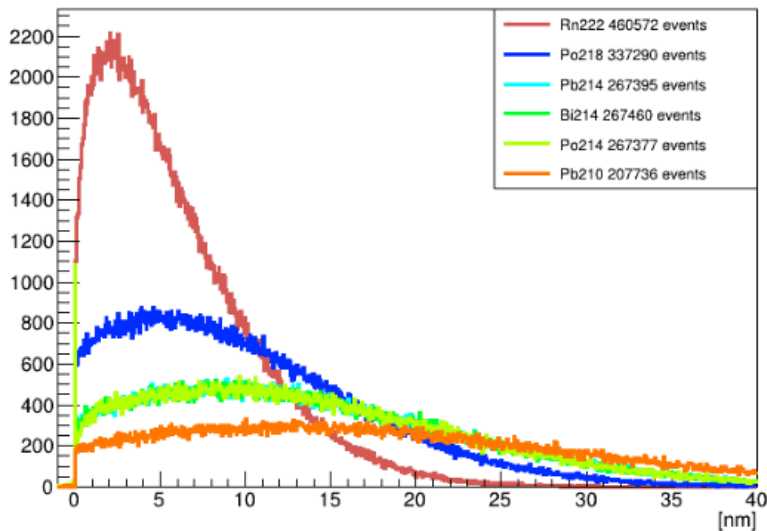
Implantation of 218Po following 10⁶ decays on a copper surface



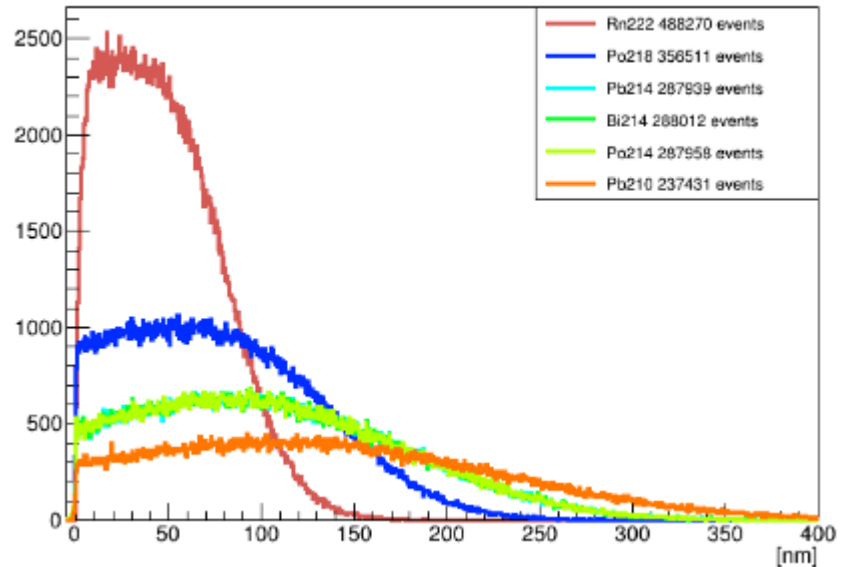
Material contamination

- Different material profiles were tested use this physic list, isotropic decay

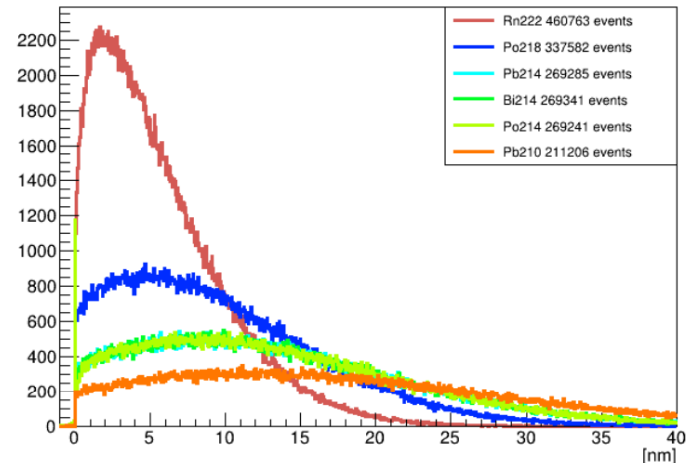
Implantation of ^{222}Rn following 10^6 decays on a Bronze surface



Implantation of ^{222}Rn following 10^6 decays on a polyethylen surface



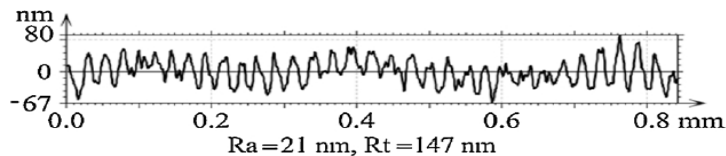
Implantation of ^{222}Rn following 10^6 decays on a copper surface



Surface modeling

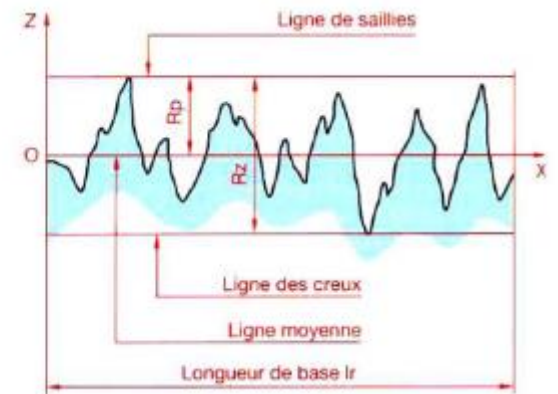
- What was shown before used GEANT4 basic box shape as target
- Reality of surface material is different

Journal of Materials Processing Tech. 288 (2021) 116899



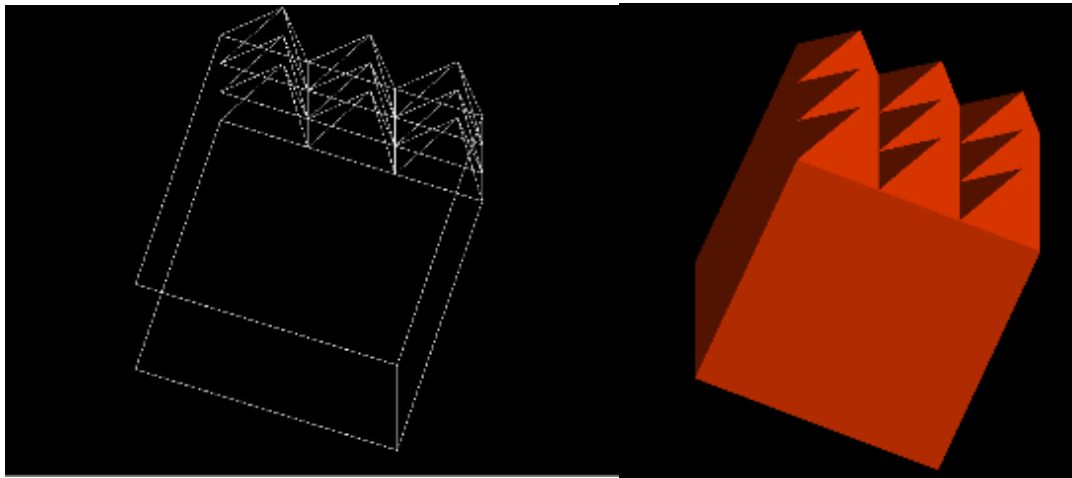
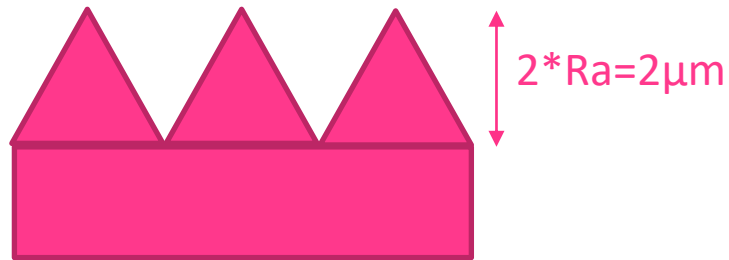
Ra is the mean half peak for a considered surface

$$Ra \equiv \frac{|z_1| + \dots + |z_n|}{n}$$



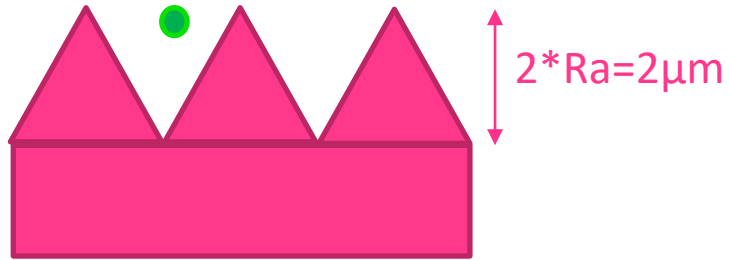
Surface model

- Surface modeled as 9 pyramids over a cube $20\mu\text{m}$

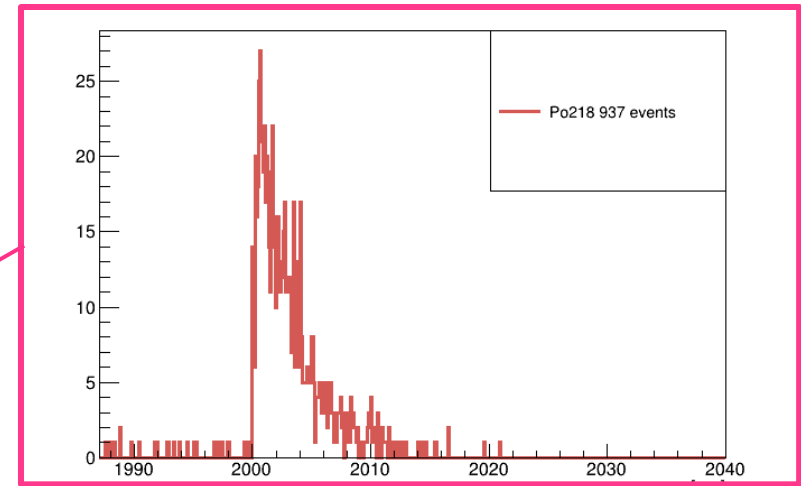
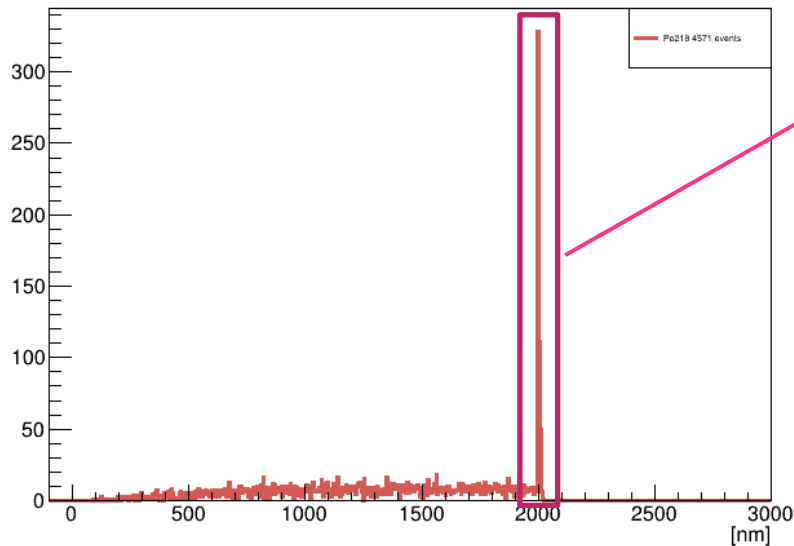


Surface implantation model

Decay : point $z=0$, iso



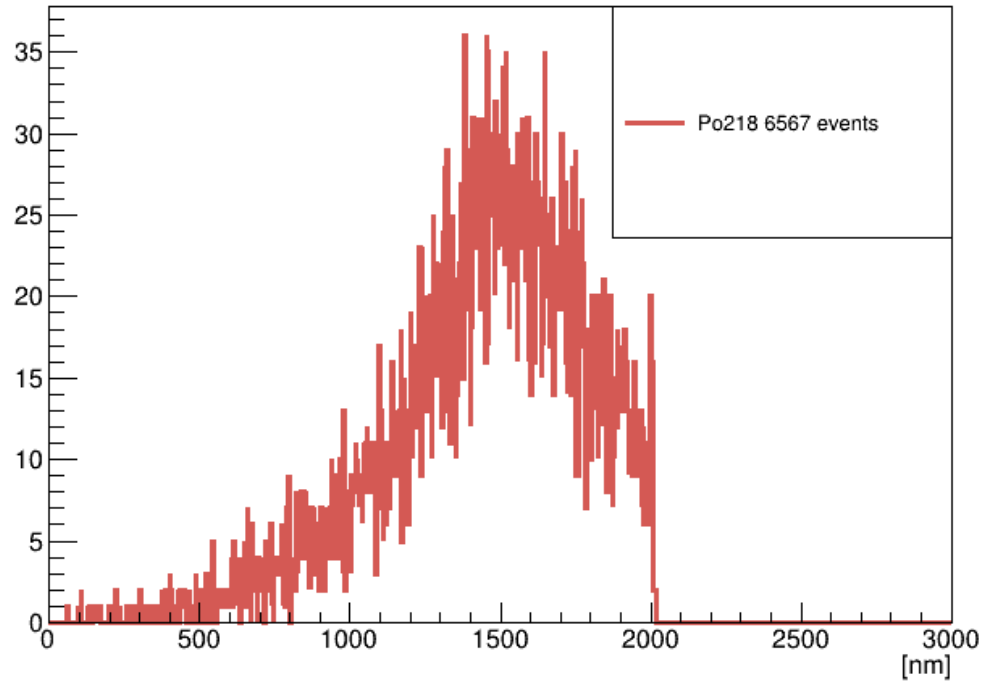
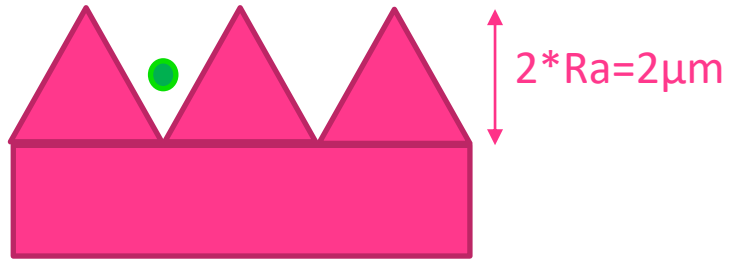
Decay of 218 at $z=0$, between 2 pyramids,
implantation depth



Zoom at the bottom of valley

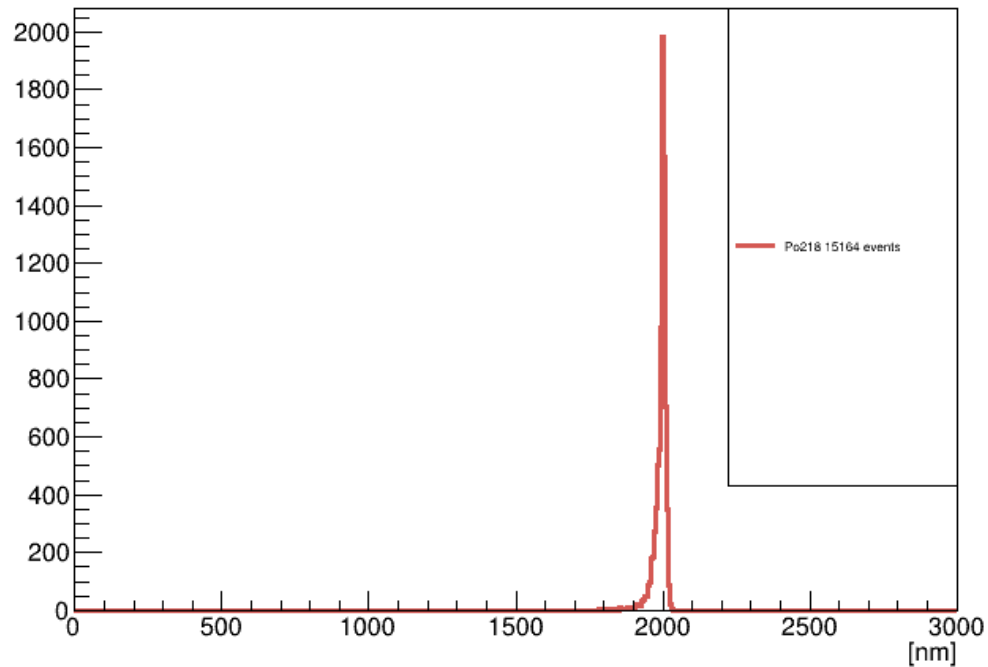
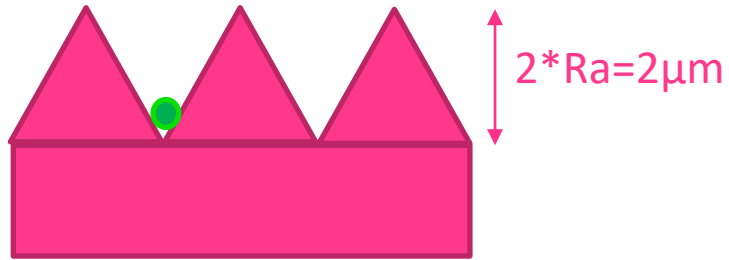
Surface implantation model

Decay : point $z=-1,5$, iso



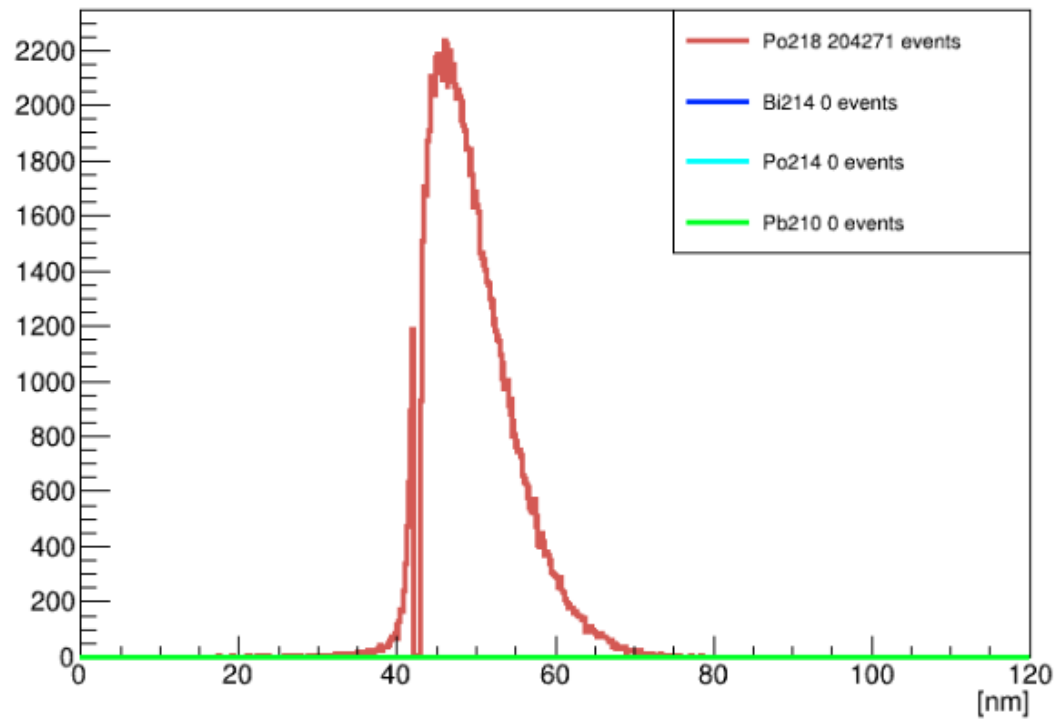
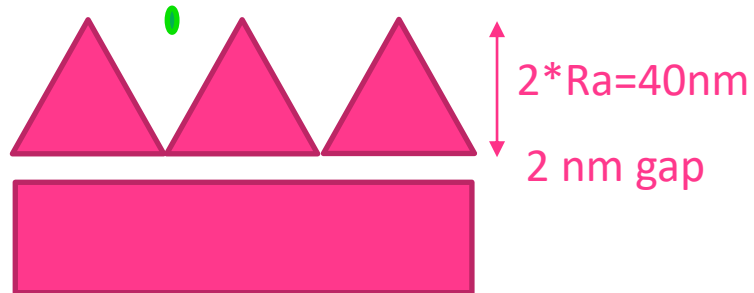
Surface event modeling

Decay : point $z=-1,98$, iso



Surface modelling

Decay : point $z=0$, iso



Conclusion

- Debugging work mainly done by Malou Cattaneo
- Radon implantation background is now a concern for underground experiments
- Evidence for 100 nm scale implantation depth rather than μm
- Simulation of implantation perform with GEANT4 in good agreement with SRIM
- Surface modelling ongoing to have a more accurate model of depth distribution
- Compare with experimental implantation in real material

Backup 1

- Example of chemical cleaning $>10\mu\text{m}$
 - Electropolish of Stainless steel: Schnee et al, AIP LRT Conference Proceeding (2013)
 - Cu etching and electroplating: Bunker et al, NIM A, 2020
 - Polymers (PTFE) Leaching: Bruenner et al, Eur Phys. J. 2021
 - Metals (Cu, SS, Ge) etching and electropolishing: Zuzel et al, AIP LRT Conference Proceeding (2018)
 - Silicon crystal sidewall etching: Street et al, NIM A, 2020

GEANT4 Config

- Geant 4 10.7 p2 from CENBG VM package
- Physics list StandardNR from example TestEm7
- Mendenhall, M. H., & Weller, R. A. (2005). An algorithm for computing screened Coulomb scattering in Geant4. *Nuclear Instruments and Methods in Physics Research Section B: Beam Interactions with Materials and Atoms*, 227(3), 420-430.

